74AUP1G17

Low-power Schmitt trigger

Rev. 14 — 18 July 2023 Product data sheet

1. General description

The 74AUP1G17 is a single buffer with Schmitt-trigger input. This device ensures very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V. This device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- CMOS low power dissipation
- High noise immunity
- Overvoltage tolerant inputs to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Low static power consumption; I_{CC} = 0.9 µA (maximum)
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 3A exceeds 5000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Multiple package options
- Specified from -40 ° C to +85 ° C and -40 ° C to +125 ° C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AUP1G17GW	-40 ° C to +125 ° C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74AUP1G17GV	-40 ° C to +125 ° C	SC-74A	plastic surface-mounted package; 5 leads	SOT753
74AUP1G17GM	-40 ° C to +125 ° C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74AUP1G17GN	-40 ° C to +125 ° C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115
74AUP1G17GS	-40 ° C to +125 ° C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202
74AUP1G17GX	-40 ° C to +125 ° C	X2SON5	plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 × 0.8 × 0.32 mm	SOT1226-3
74AUP1G17GX4	-40 °C to +125 °C	X2SON4	plastic thermal enhanced extremely thin small outline package; no leads; 4 terminals; body 0.6 × 0.6 × 0.32 mm	SOT1269-2

4. Marking

Table 2. Marking

Type number	Marking code[1]
74AUP1G17GW	pJ
74AUP1G17GV	pJ
74AUP1G17GM	pJ
74AUP1G17GN	pJ
74AUP1G17GS	pJ
74AUP1G17GX	pJ
74AUP1G17GX4	pJ

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

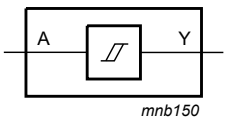


Fig. 1. Logic symbol

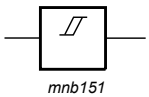


Fig. 2. IEC logic symbol

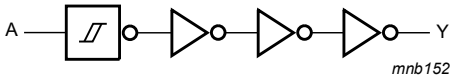
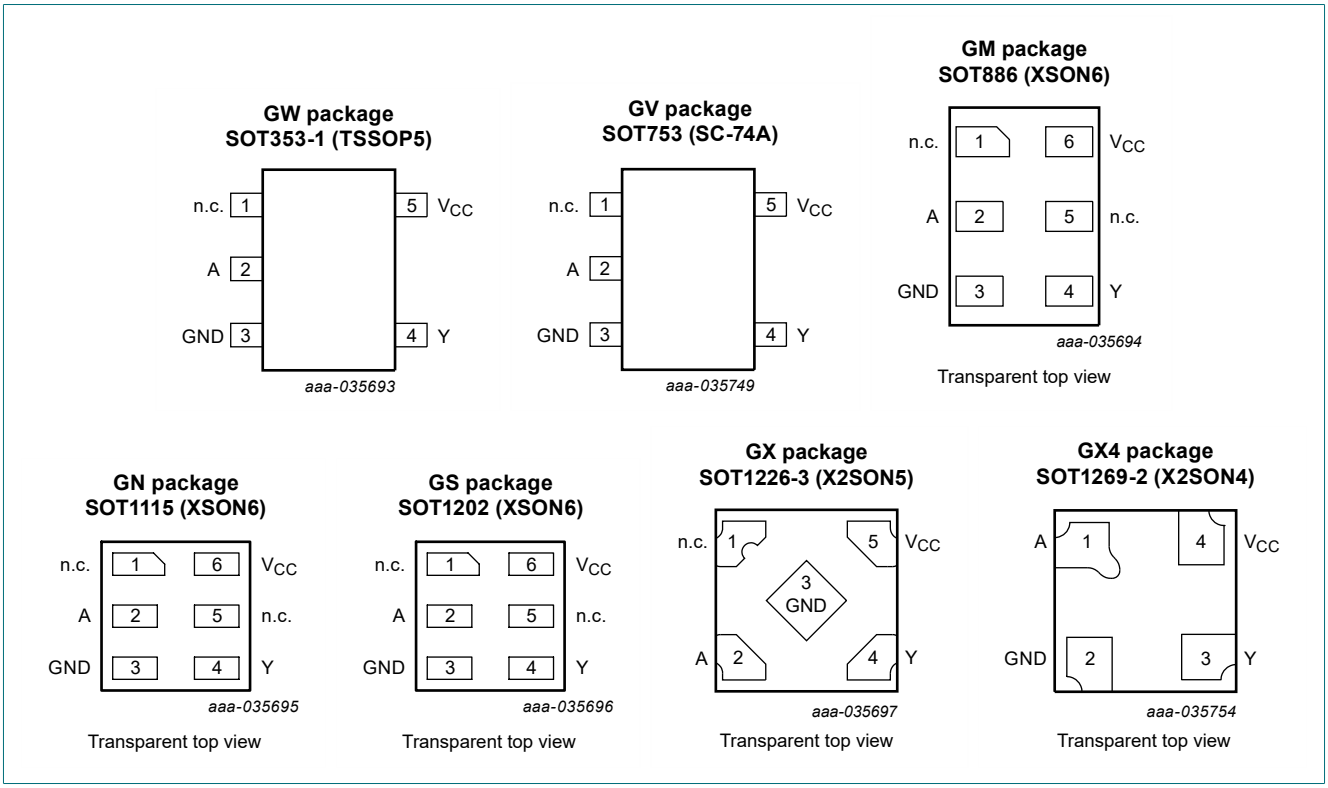


Fig. 3. Logic diagram

6. Pinning information

6.1. Pinning



6.2. Pin description

Table 3. Pin description

Symbol	Pin			Description
	SC-74A, TSSOP5 and X2SON5	XSON6	X2SON4	
n.c.	1	1, 5	-	not connected
A	2	2	1	data input
GND	3	3	2	ground (0 V)
Y	4	4	3	data output
V_{CC}	5	6	4	supply voltage

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level.

Input	Output
A	**Y**
L	L
H	H

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+4.6	V
I_{IK}	input clamping current	$V_I < 0$ V		-50	-	mA
V_I	input voltage		[1]	-0.5	+4.6	V
I_{OK}	output clamping current	$V_O < 0$ V		-50	-	mA
V_O	output voltage	Active mode and Power-down mode	[1]	-0.5	+4.6	V
I_O	output current	V_O = 0 V to V_{CC}		-	±20	mA
I_{CC}	supply current			-	+50	mA
I_{GND}	ground current			-50	-	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C				
		SOT353-1 (TSSOP5) SOT753 (SC-74A) SOT886 (XSON6) SOT1115 (XSON6) SOT1202 (XSON6) SOT1226-3 (X2SON5)	[2]	-	250	mW
		SOT1269-2 (X2SON4)	[3]	-	150	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SOT353-1 (TSSOP5) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT753 (SC-74A) package: P_{tot} derates linearly with 3.8 mW/K above 85 °C.
For SOT886 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT1115 (XSON6) package: P_{tot} derates linearly with 3.2 mW/K above 71 °C.
For SOT1202 (XSON6) package: P_{tot} derates linearly with 3.3 mW/K above 74 °C.
For SOT1226-3 (X2SON5) package: P_{tot} derates linearly with 3.0 mW/K above 67 °C.

[3] For SOT1269-2 (X2SON4) package: P_{tot} derates linearly with 1.7 mW/K above 57 °C.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		0.8	3.6	V
V_I	input voltage		0	3.6	V
V_O	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; V_{CC} = 0 V	0	3.6	V
T_{amb}	ambient temperature		-40	+125	°C

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{OH}	HIGH-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = -20 µA; V_{CC} = 0.8 V to 3.6 V	V_{CC} - 0.1	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V	0.75 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V	1.11	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V	1.32	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V	2.05	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V	1.9	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V	2.72	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V	2.6	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = 20 µA; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V	-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V	-	-	0.31	V
		I_O = 1.9 mA; V_{CC} = 1.65 V	-	-	0.31	V
		I_O = 2.3 mA; V_{CC} = 2.3 V	-	-	0.31	V
		I_O = 3.1 mA; V_{CC} = 2.3 V	-	-	0.44	V
		I_O = 2.7 mA; V_{CC} = 3.0 V	-	-	0.31	V
		I_O = 4.0 mA; V_{CC} = 3.0 V	-	-	0.44	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.1	µA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.2	µA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V	-	-	±0.2	µA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	0.5	µA
ΔI_{CC}	additional supply current	$V_I = V_{CC}$ - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	-	-	40	µA
C_I	input capacitance	V_I = GND or V_{CC}; V_{CC} = 0 V to 3.6 V	-	1.1	-	pF
C_O	output capacitance	V_O = GND; V_{CC} = 0 V	-	1.7	-	pF

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = -40 °C to +85 °C						
V_{OH}	HIGH-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = -20 µA; V_{CC} = 0.8 V to 3.6 V	V_{CC} - 0.1	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V	0.7 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V	1.03	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V	1.30	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V	1.97	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V	1.85	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V	2.67	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V	2.55	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{T+}$ or V_{T-}				
		I_O = 20 µA; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V	-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V	-	-	0.37	V
		I_O = 1.9 mA; V_{CC} = 1.65 V	-	-	0.35	V
		I_O = 2.3 mA; V_{CC} = 2.3 V	-	-	0.33	V
		I_O = 3.1 mA; V_{CC} = 2.3 V	-	-	0.45	V
		I_O = 2.7 mA; V_{CC} = 3.0 V	-	-	0.33	V
		I_O = 4.0 mA; V_{CC} = 3.0 V	-	-	0.45	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.5	µA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.5	µA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V	-	-	±0.6	µA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	0.9	µA
ΔI_{CC}	additional supply current	$V_I = V_{CC}$ - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	-	-	50	µA

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = -40 °C to +125 °C						
V_{OH}	HIGH-level output voltage	V_I = V_{T+} or V_{T-}				
		I_O = -20 µA; V_{CC} = 0.8 V to 3.6 V	V_{CC} - 0.11	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V	0.6 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V	0.93	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V	1.17	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V	1.77	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V	1.67	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V	2.40	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V	2.30	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{T+} or V_{T-}				
		I_O = 20 µA; V_{CC} = 0.8 V to 3.6 V	-	-	0.11	V
		I_O = 1.1 mA; V_{CC} = 1.1 V	-	-	0.33 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V	-	-	0.41	V
		I_O = 1.9 mA; V_{CC} = 1.65 V	-	-	0.39	V
		I_O = 2.3 mA; V_{CC} = 2.3 V	-	-	0.36	V
		I_O = 3.1 mA; V_{CC} = 2.3 V	-	-	0.50	V
		I_O = 2.7 mA; V_{CC} = 3.0 V	-	-	0.36	V
		I_O = 4.0 mA; V_{CC} = 3.0 V	-	-	0.50	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.75	µA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.75	µA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V	-	-	±0.75	µA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	1.4	µA
ΔI_{CC}	additional supply current	V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	-	-	75	µA

11. Dynamic characteristics

Table 8. Dynamic characteristics

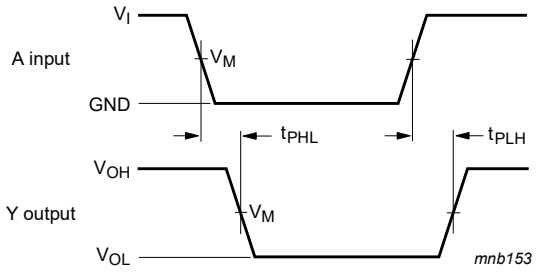
Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 5

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
C_L = 5 pF										
t_{pd}	propagation delay	A to Y; see Fig. 4 [2]								
		V_{CC} = 0.8 V	-	19.0	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.6	5.7	10.6	2.5	10.9	2.5	11.1	ns
		V_{CC} = 1.4 V to 1.6 V	2.4	4.2	6.5	2.3	7.1	2.3	7.4	ns
		V_{CC} = 1.65 V to 1.95 V	2.0	3.6	5.5	1.9	6.1	1.9	6.3	ns
		V_{CC} = 2.3 V to 2.7 V	1.9	3.0	4.2	1.8	4.6	1.8	4.8	ns
		V_{CC} = 3.0 V to 3.6 V	1.8	2.7	3.6	1.5	3.8	1.5	4.0	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
C_L = 10 pF										
t_{pd}	propagation delay	A to Y; see Fig. 4 [2]								
		V_{CC} = 0.8 V	-	22.5	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.9	6.6	12.4	2.7	12.9	2.7	13.0	ns
		V_{CC} = 1.4 V to 1.6 V	2.6	4.8	7.8	2.4	8.3	2.4	8.7	ns
		V_{CC} = 1.65 V to 1.95 V	2.5	4.2	6.3	2.4	6.8	2.4	7.1	ns
		V_{CC} = 2.3 V to 2.7 V	2.3	3.5	4.8	2.1	5.3	2.1	5.6	ns
		V_{CC} = 3.0 V to 3.6 V	2.1	3.3	4.4	2.0	4.6	2.0	4.8	ns
C_L = 15 pF										
t_{pd}	propagation delay	A to Y; see Fig. 4 [2]								
		V_{CC} = 0.8 V	-	26.0	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.2	7.4	14.1	3.1	14.7	3.1	14.9	ns
		V_{CC} = 1.4 V to 1.6 V	3.1	5.4	8.7	2.8	9.5	2.8	9.9	ns
		V_{CC} = 1.65 V to 1.95 V	2.7	4.7	7.1	2.7	7.8	2.7	8.2	ns
		V_{CC} = 2.3 V to 2.7 V	2.6	4.0	5.6	2.5	6.0	2.5	6.3	ns
		V_{CC} = 3.0 V to 3.6 V	2.5	3.7	4.9	2.2	5.2	2.2	5.5	ns
C_L = 30 pF										
t_{pd}	propagation delay	A to Y; see Fig. 4 [2]								
		V_{CC} = 0.8 V	-	36.3	-	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.9	9.7	19.0	3.7	19.8	3.7	20.1	ns
		V_{CC} = 1.4 V to 1.6 V	3.5	7.0	11.2	3.6	12.4	3.6	13.0	ns
		V_{CC} = 1.65 V to 1.95 V	3.5	6.0	9.2	3.4	10.1	3.4	10.7	ns
		V_{CC} = 2.3 V to 2.7 V	3.4	5.1	7.0	3.2	7.5	3.2	7.9	ns
		V_{CC} = 3.0 V to 3.6 V	3.3	4.8	6.2	3.1	7.1	3.1	7.5	ns
C_L = 5 pF, 10 pF, 15 pF and 30 pF										
C_{PD}	power dissipation capacitance	f = 1 MHz; V_I = GND to V_{CC} [3]								
		V_{CC} = 0.8 V	-	2.5	-	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V	-	2.7	-	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V	-	2.8	-	-	-	-	-	pF
		V_{CC} = 1.65 V to 1.95 V	-	3.0	-	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	3.5	-	-	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V	-	4.0	-	-	-	-	-	pF

[1] All typical values are measured at nominal V_{CC}.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}
[3] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

11.1. Waveform and test circuit



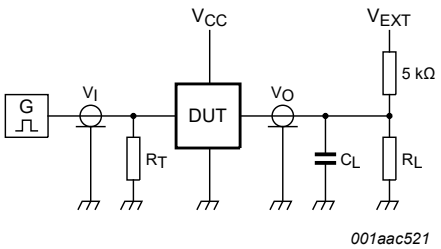
Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig. 4. The data input (A) to output (Y) propagation delays

Table 9. Measurement points

Supply voltage	Input			Output
V_{CC}	V_M	V_I	$t_r = t_f$	V_M
0.8 V to 3.6 V	0.5 × V_{CC}	V_{CC}	≤ 3.0 ns	0.5 × V_{CC}



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig. 5. Test circuit for measuring switching times

Table 10. Test data

Supply voltage	Load		V_{EXT}		
V_{CC}	C_L	R_L [1]	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	2 × V_{CC}

[1] For measuring enable and disable times, R_L = 5 kΩ.
For measuring propagation delays, setup and hold times and pulse width R_L = 1 MΩ.

12. Transfer characteristics

Table 11. Transfer characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{T+}	positive-going threshold voltage	see Fig. 6 and Fig. 7				
		V_{CC} = 0.8 V	0.30	-	0.60	V
		V_{CC} = 1.1 V	0.53	-	0.90	V
		V_{CC} = 1.4 V	0.74	-	1.11	V
		V_{CC} = 1.65 V	0.91	-	1.29	V
		V_{CC} = 2.3 V	1.37	-	1.77	V
		V_{CC} = 3.0 V	1.88	-	2.29	V
V_{T-}	negative-going threshold voltage	see Fig. 6 and Fig. 7				
		V_{CC} = 0.8 V	0.10	-	0.60	V
		V_{CC} = 1.1 V	0.26	-	0.65	V
		V_{CC} = 1.4 V	0.39	-	0.75	V
		V_{CC} = 1.65 V	0.47	-	0.84	V
		V_{CC} = 2.3 V	0.69	-	1.04	V
		V_{CC} = 3.0 V	0.88	-	1.24	V
V_H	hysteresis voltage	see Fig. 6, Fig. 7, Fig. 8 and Fig. 9				
		V_{CC} = 0.8 V	0.07	-	0.50	V
		V_{CC} = 1.1 V	0.08	-	0.46	V
		V_{CC} = 1.4 V	0.18	-	0.56	V
		V_{CC} = 1.65 V	0.27	-	0.66	V
		V_{CC} = 2.3 V	0.53	-	0.92	V
		V_{CC} = 3.0 V	0.79	-	1.31	V

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = -40 °C to +85 °C						
V_{T+}	positive-going threshold voltage	see Fig. 6 and Fig. 7				
		V_{CC} = 0.8 V	0.30	-	0.60	V
		V_{CC} = 1.1 V	0.53	-	0.90	V
		V_{CC} = 1.4 V	0.74	-	1.11	V
		V_{CC} = 1.65 V	0.91	-	1.29	V
		V_{CC} = 2.3 V	1.37	-	1.77	V
		V_{CC} = 3.0 V	1.88	-	2.29	V
V_{T-}	negative-going threshold voltage	see Fig. 6 and Fig. 7				
		V_{CC} = 0.8 V	0.10	-	0.60	V
		V_{CC} = 1.1 V	0.26	-	0.65	V
		V_{CC} = 1.4 V	0.39	-	0.75	V
		V_{CC} = 1.65 V	0.47	-	0.84	V
		V_{CC} = 2.3 V	0.69	-	1.04	V
		V_{CC} = 3.0 V	0.88	-	1.24	V
V_H	hysteresis voltage	see Fig. 6, Fig. 7, Fig. 8 and Fig. 9				
		V_{CC} = 0.8 V	0.07	-	0.50	V
		V_{CC} = 1.1 V	0.08	-	0.46	V
		V_{CC} = 1.4 V	0.18	-	0.56	V
		V_{CC} = 1.65 V	0.27	-	0.66	V
		V_{CC} = 2.3 V	0.53	-	0.92	V
		V_{CC} = 3.0 V	0.79	-	1.31	V
T_{amb} = -40 °C to +125 °C						
V_{T+}	positive-going threshold voltage	see Fig. 6 and Fig. 7				
		V_{CC} = 0.8 V	0.30	-	0.62	V
		V_{CC} = 1.1 V	0.53	-	0.92	V
		V_{CC} = 1.4 V	0.74	-	1.13	V
		V_{CC} = 1.65 V	0.91	-	1.31	V
		V_{CC} = 2.3 V	1.37	-	1.80	V
		V_{CC} = 3.0 V	1.88	-	2.32	V
V_{T-}	negative-going threshold voltage	see Fig. 6 and Fig. 7				
		V_{CC} = 0.8 V	0.10	-	0.60	V
		V_{CC} = 1.1 V	0.26	-	0.65	V
		V_{CC} = 1.4 V	0.39	-	0.75	V
		V_{CC} = 1.65 V	0.47	-	0.84	V
		V_{CC} = 2.3 V	0.69	-	1.04	V
		V_{CC} = 3.0 V	0.88	-	1.24	V
V_H	hysteresis voltage	see Fig. 6, Fig. 7, Fig. 8 and Fig. 9				
		V_{CC} = 0.8 V	0.07	-	0.50	V
		V_{CC} = 1.1 V	0.08	-	0.46	V
		V_{CC} = 1.4 V	0.18	-	0.56	V
		V_{CC} = 1.65 V	0.27	-	0.66	V
		V_{CC} = 2.3 V	0.53	-	0.92	V
		V_{CC} = 3.0 V	0.79	-	1.31	V

12.1. Waveforms transfer characteristics

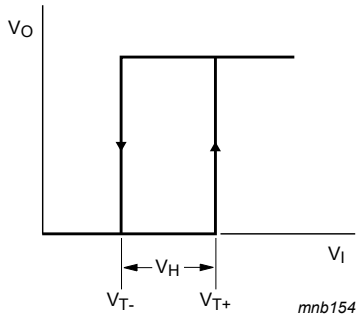
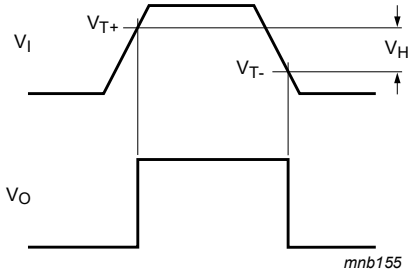


Fig. 6. Transfer characteristic



V_{T+} and V_{T-} limits at 70 % and 20 %.

Fig. 7. Definition of V_{T+}, V_{T-} and V_H

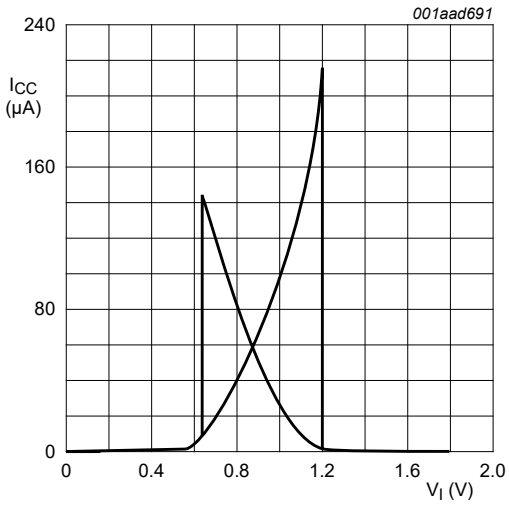


Fig. 8. Typical transfer characteristics; V_{CC} = 1.8 V

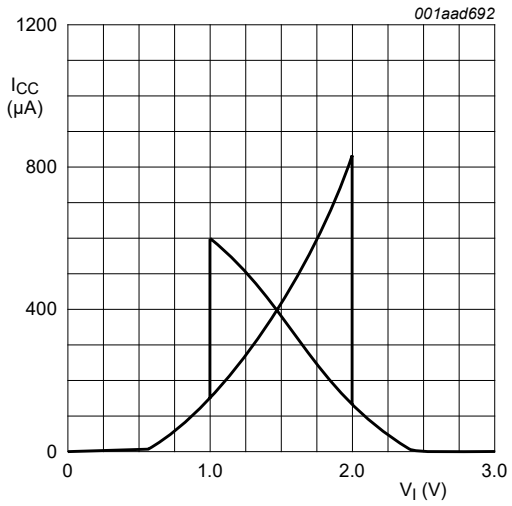


Fig. 9. Typical transfer characteristics; V_{CC} = 3.0 V

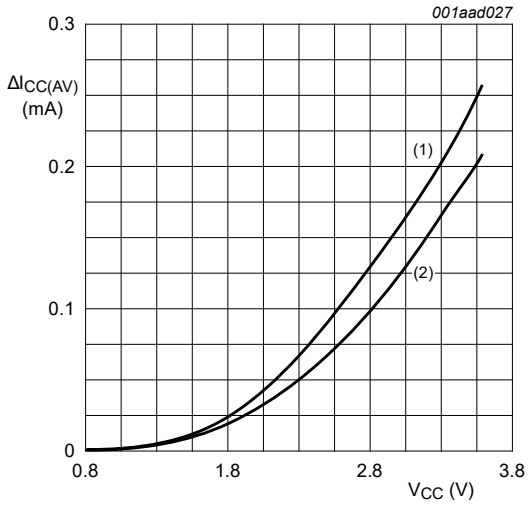
13. Application information

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

$P_{ad} = f_i \times (t_r \times I_{CC(AV)} + t_f \times I_{CC(AV)}) \times V_{CC}$ where:

- P_{ad} = additional power dissipation (μW);
- f_i = input frequency (MHz);
- t_r = input rise time (ns); 10 % to 90 %;
- t_f = input fall time (ns); 90 % to 10 %;
- $I_{CC(AV)}$ = average additional supply current (μA).

Average I_{CC} differs with positive or negative input transitions, as shown in Fig. 10.



(1) Positive-going edge.

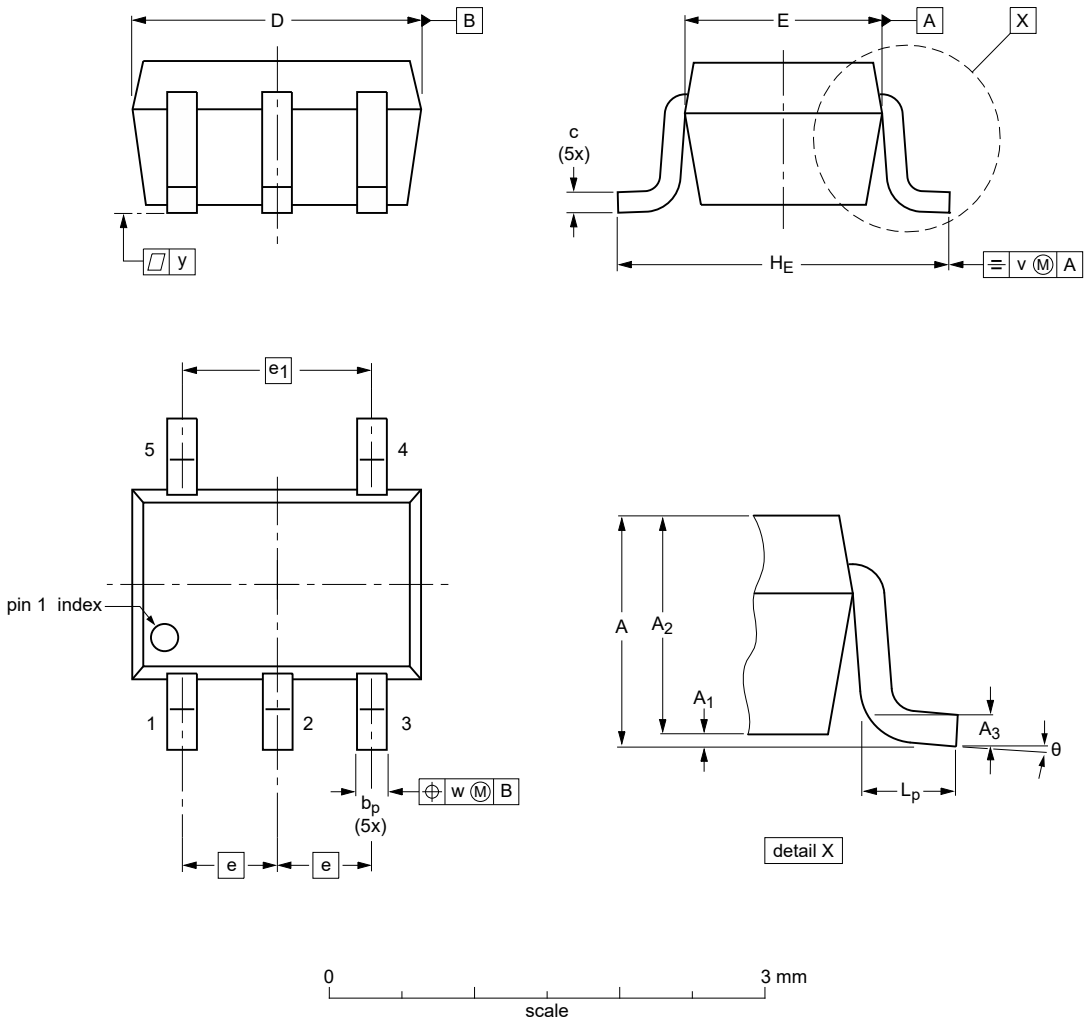
(2) Negative-going edge.

Linear change of V_I between 0.8 V and 2.0 V. All values given are typical, unless otherwise specified.

Fig. 10. Average I_{CC} as a function of V_{CC}

14. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm **SOT353-1**



Dimensions (mm are the original dimensions)

Unit		A	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	e_1	H_E	L_p	v	w	y	θ
mm	max	1.1	0.1	1.0	0.15	0.30	0.25	2.2	1.35	0.65	1.3	2.4	0.46	0.3	0.1	0.1	8°
	min	0.8	0	0.8		0.15	0.08	1.8	1.15			1.8	0.26				0°

Note

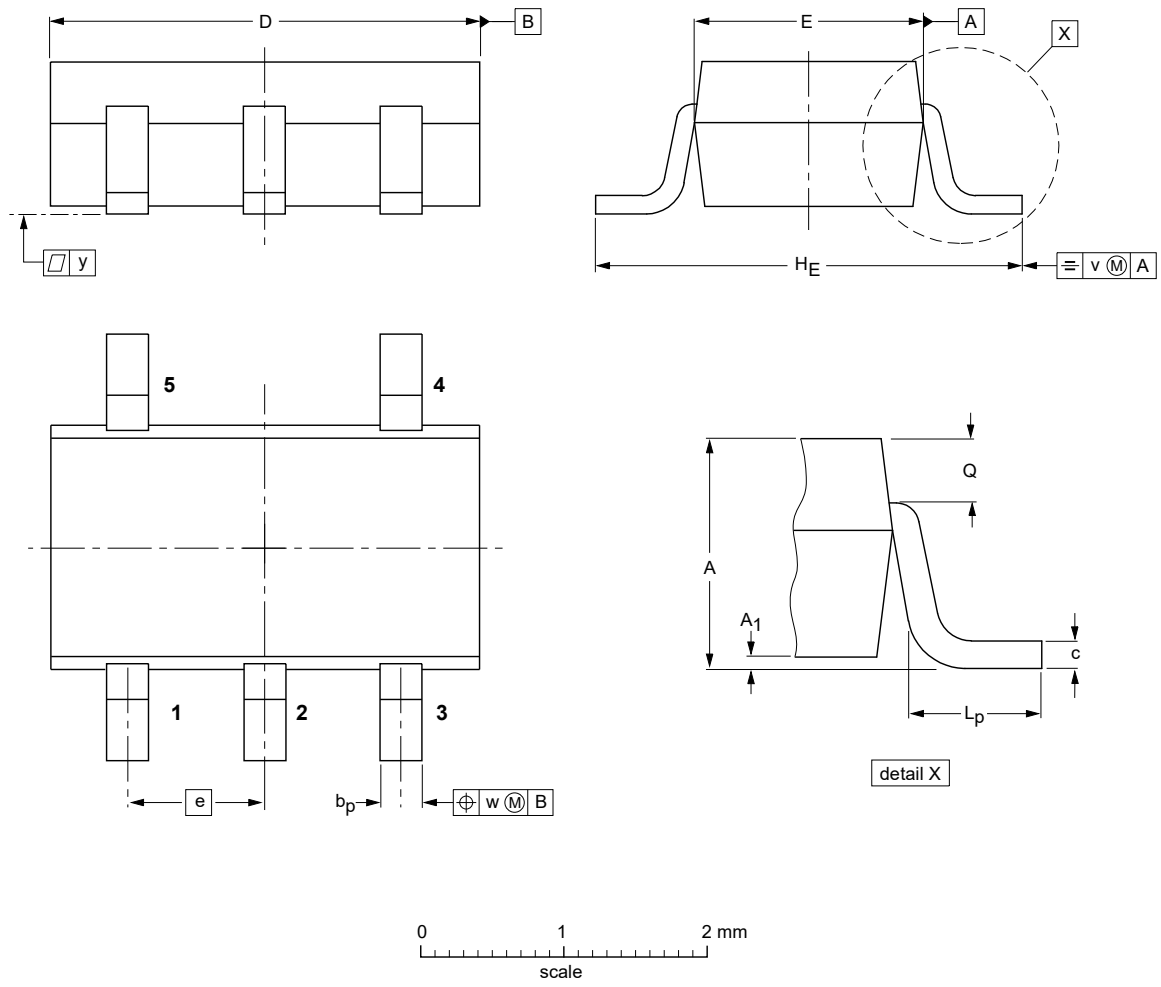
1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

sot353-1_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT353-1		MO-203	SC-88A			~~21-12-15~~ 21-12-16

Fig. 11. Package outline SOT353-1 (TSSOP5)

Plastic surface-mounted package; 5 leads **SOT753**



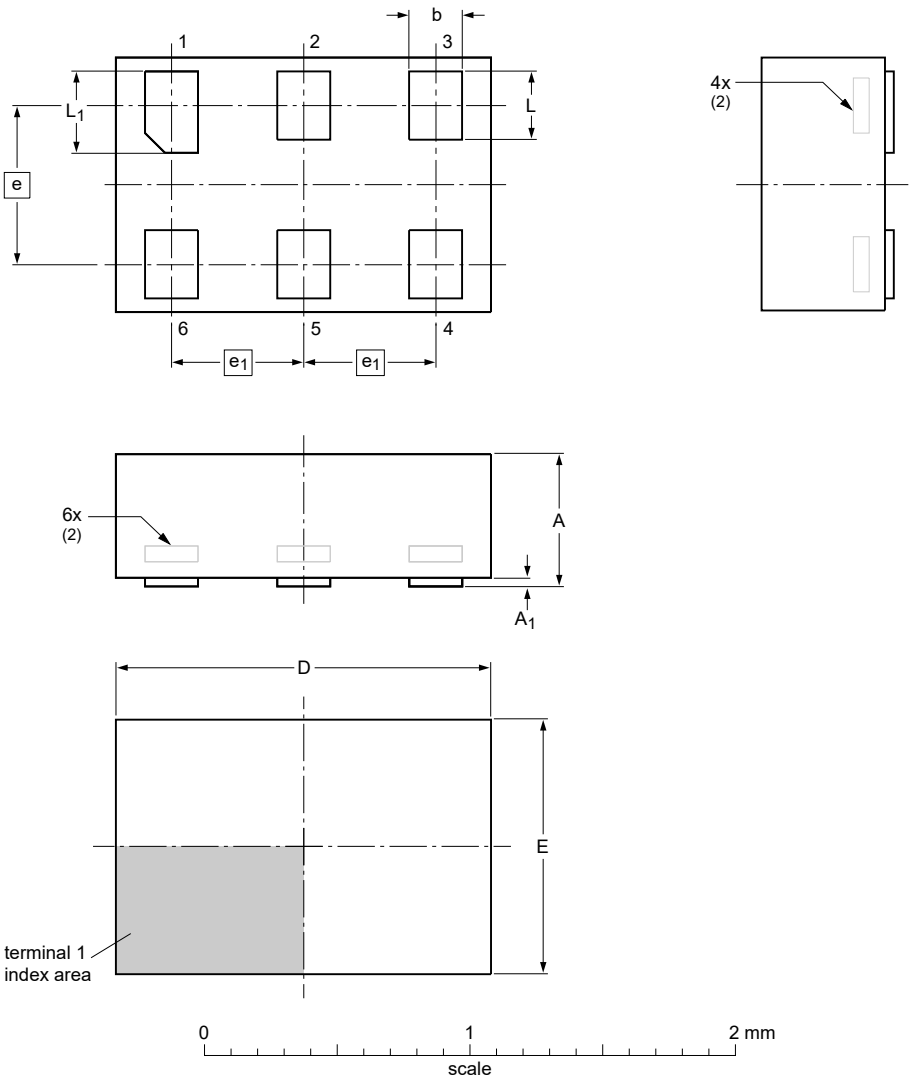
DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1	b_p	c	D	E	e	H_E	L_p	Q	v	w	y
mm	1.1 0.9	0.100 0.013	0.40 0.25	0.26 0.10	3.1 2.7	1.7 1.3	0.95	3.0 2.5	0.6 0.2	0.33 0.23	0.2	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT753			SC-74A			~~02-04-16~~ 06-03-16

Fig. 12. Package outline SOT753 (SC-74A)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm SOT886



Dimensions (mm are the original dimensions)

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.5	0.04	0.25	1.50	1.05			0.35	0.40
	nom			0.20	1.45	1.00	0.6	0.5	0.30	0.35
	min			0.17	1.40	0.95			0.27	0.32

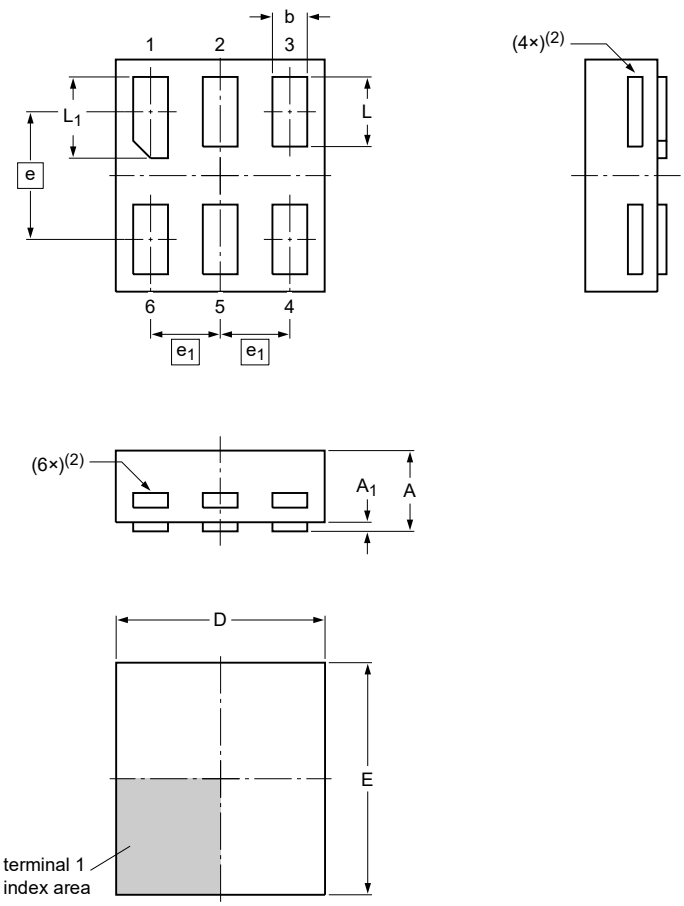
Notes
1. Including plating thickness.
2. Can be visible in some manufacturing processes.

sot886_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT886		MO-252				~~04-07-22~~ 12-01-05

Fig. 13. Package outline SOT886 (XSON6)

XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm **SOT1115**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	0.95	1.05			0.35	0.40
	nom			0.15	0.90	1.00	0.55	0.3	0.30	0.35
	min			0.12	0.85	0.95			0.27	0.32

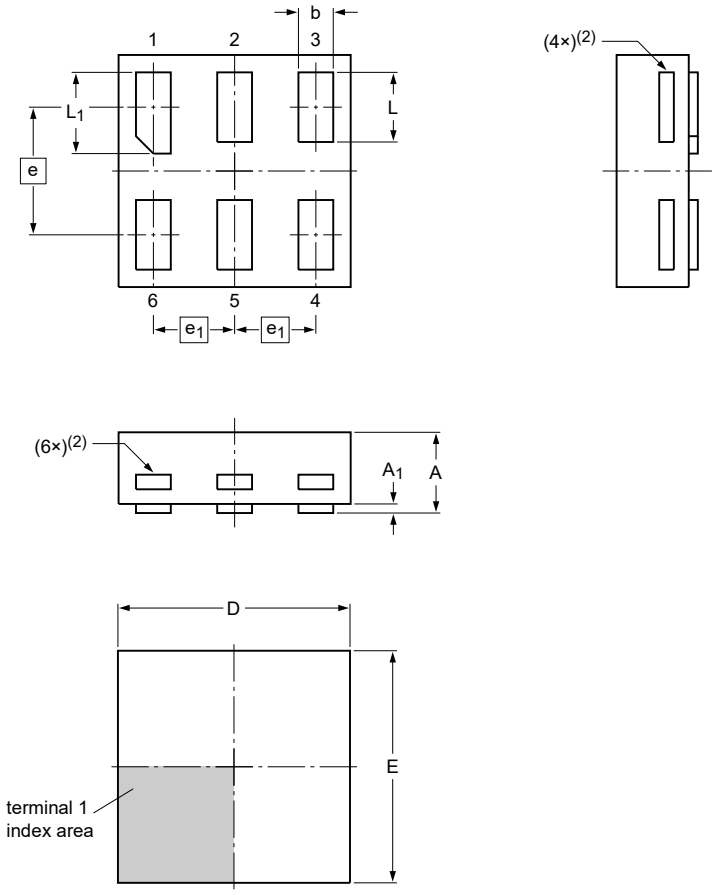
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1115_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1115						~~10-04-02~~ 10-04-07

Fig. 14. Package outline SOT1115 (XSON6)

XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm **SOT1202**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	1.05	1.05			0.35	0.40
	nom			0.15	1.00	1.00	0.55	0.35	0.30	0.35
	min			0.12	0.95	0.95			0.27	0.32

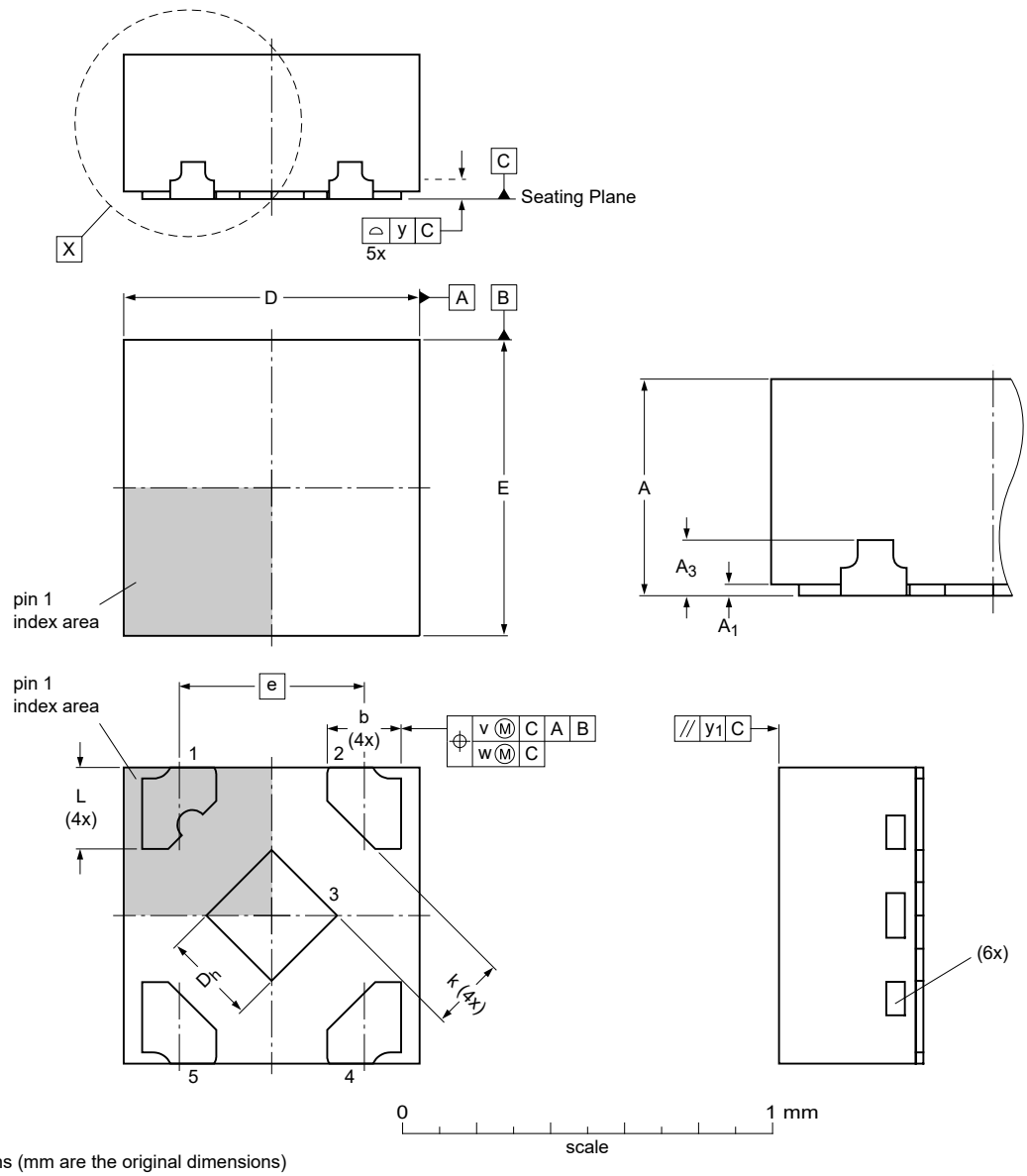
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1202_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1202						~~10-04-02~~ 10-04-06

Fig. 15. Package outline SOT1202 (XSON6)

X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 x 0.8 x 0.32 mm **SOT1226-3**



Dimensions (mm are the original dimensions)

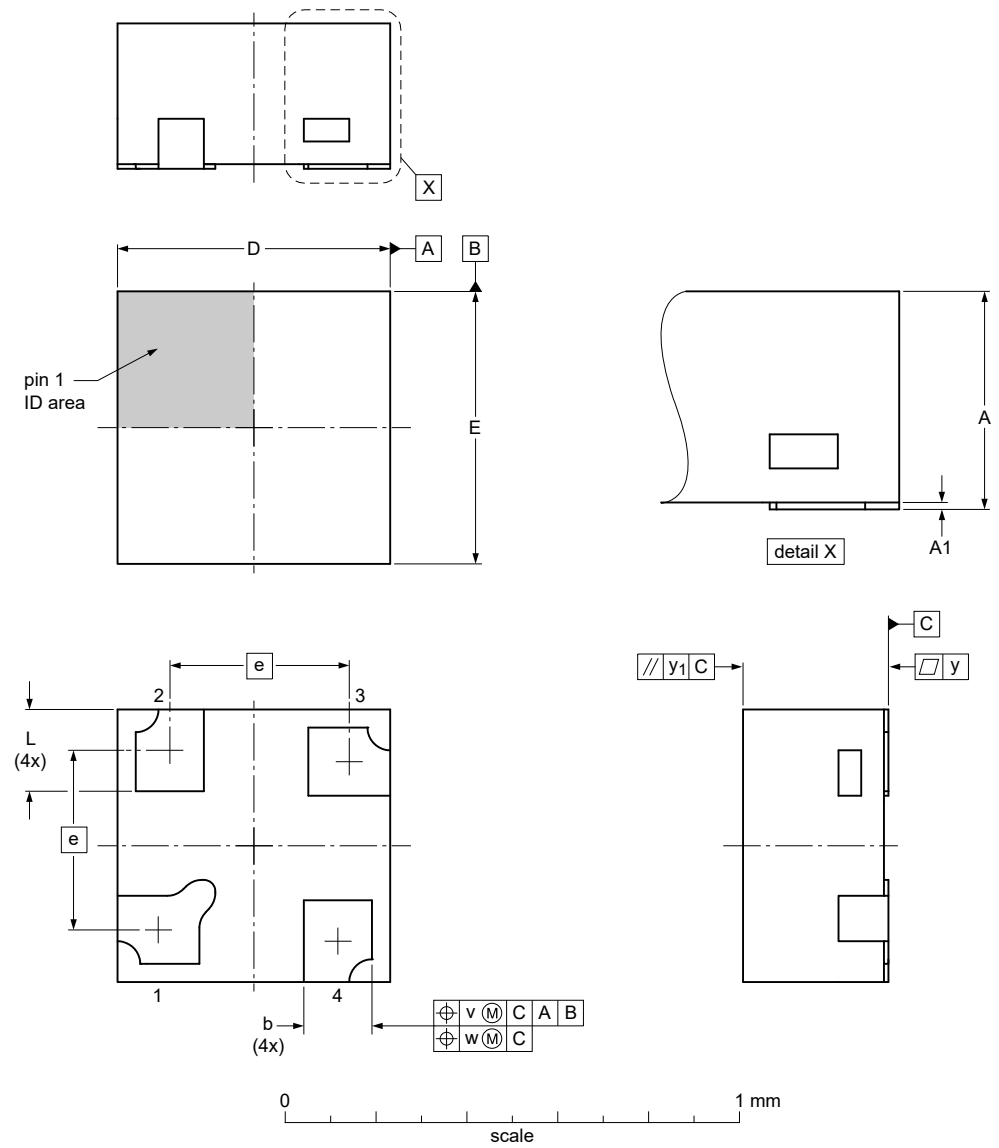
Unit		A	A_1	A_3	D	D_h	E	b	e	K	L	v	w	y	y_1
mm	max	0.35	0.04	0.10 (Typ.)	0.85	0.30	0.85	0.25	0.50		0.27	0.1	0.05	0.05	0.05
	nom	0.32	0.02		0.80	0.25	0.80	0.20			0.22				
	min	0.30	0.00		0.75	0.20	0.75	0.15		0.20	0.17				

sot1226-3_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	EIAJ			
SOT1226-3		---				~~19-11-06~~ 19-11-07

Fig. 16. Package outline SOT1226-3 (X2SON5)

X2SON4: plastic thermal enhanced extremely thin small outline package; no leads; 4 terminals; body 0.6 x 0.6 x 0.32 mm **SOT1269-2**



Dimensions (mm are the original dimensions)

Unit	A	A_1	D	E	b	e	L	v	w	y	y_1
max	0.35	0.04	0.65	0.65	0.20		0.23				
mm nom	0.32	0.02	0.60	0.60	0.15	0.40	0.18	0.10	0.05	0.05	0.05
min	0.30	0.00	0.55	0.55	0.10		0.13				

sot1269-2_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1269-2		---				~~17-04-07~~ 17-06-30

Fig. 17. Package outline SOT1269-2 (X2SON4)

15. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model

16. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G17 v.14	20230713	Product data sheet	-	74AUP1G17 v.13
Modifications:	• Section 2: ESD specification updated according to the latest JEDEC standard.			
74AUP1G17 v.13	20220113	Product data sheet	-	74AUP1G17 v.12
Modifications:	• Fig. 11: Package outline drawing for SOT353-1 (TSSOP5) has changed.			
74AUP1G17 v.12	20210707	Product data sheet	-	74AUP1G17 v.11
Modifications:	• SOT1226 (X2SON5) package changed to SOT1226-3 (X2SON5) package. • Type number 74AUP1G17GF (SOT891/XSON6) removed. • Table 5: Derating values for P_{tot} total power dissipation have been updated.			
74AUP1G17 v.11	20180608	Product data sheet	-	74AUP1G17 v.10
Modifications:	• Added type number 74AUP1G17GX4 (SOT1269-2)			
74AUP1G17 v.10	20170519	Product data sheet	-	74AUP1G17 v.9
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate.			
74AUP1G17 v.9	20161104	Product data sheet	-	74AUP1G17 v.8
Modifications:	• Added type number 74AUP1G17GV (SOT753)			
74AUP1G17 v.8	20150115	Product data sheet	-	74AUP1G17 v.7
Modifications:	• Marking code Table 2: typo corrected in type number 74AUP1G17GX.			
74AUP1G17 v.7	20120716	Product data sheet	-	74AUP1G17 v.6
Modifications:	• Package outline drawing of SOT1226 (Fig. 16) modified.			
74AUP1G17 v.6	20120412	Product data sheet	-	74AUP1G17 v.5
Modifications:	• Added type number 74AUP1G17GX (SOT1226) • Package outline drawing of SOT886 (Fig. 13) modified.			
74AUP1G17 v.5	20111124	Product data sheet	-	74AUP1G17 v.4
Modifications:	• Legal pages updated.			
74AUP1G17 v.4	20100715	Product data sheet	-	74AUP1G17 v.3
74AUP1G17 v.3	20090710	Product data sheet	-	74AUP1G17 v.2
74AUP1G17 v.2	20060727	Product data sheet	-	74AUP1G17 v.1
74AUP1G17 v.1	20050726	Product data sheet	-	-

17. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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